



DMN3732UFB4

Product Summary

| BV _{DSS} | Rds(on) | I _D Ta = +25°C |
|-------------------|--------------------------------|------------------------------|
| | 460mΩ @ V _{GS} = 4.5V | 1.3A |
| 30V | 560mΩ @ V _{GS} = 2.5V | 1.2A |
| | 730mΩ @ V _{GS} = 1.8V | 1A |

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Load switches
- Portable applications
- Power management functions

30V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- 0.4mm Ultra Low Profile Package for Thin Application
- 0.6mm² Package Footprint, 10 Times Smaller than SOT23
- Low VGS(TH), Can Be Driven Directly from A Battery
- Low RDS(ON)
- **ESD** Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/guality/product-definitions/

Mechanical Data

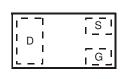
- Package: X2-DFN1006-3 .
- Package Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.001 grams (Approximate)

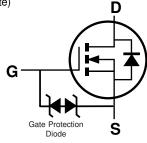




X2-DFN1006-3

Bottom View





Pin-out Top View

Equivalent Circuit

Ordering Information (Note 4)

| I | Davit Number | Deekers | Maukina | | | Tape Pitch (mm) | Packing | | |
|---|----------------|--------------|----------------------|---|---------------------------------|-----------------|---------|---------|--|
| | Part Number | Раскаде | Package Marking Reel | | I Size (inches) Tape Width (mm) | | Qty. | Carrier | |
| | DMN3732UFB4-7B | X2-DFN1006-3 | BF | 7 | 8 | 2 | 10,000 | Reel | |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

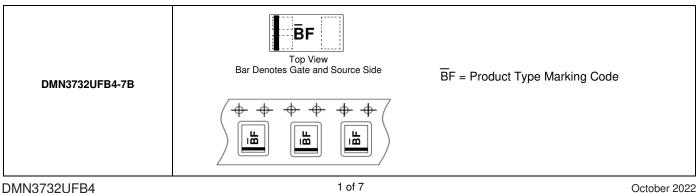
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Unit | |
|--|-----------------|---|--------|------------|------|--|
| Drain-Source Voltage | | | VDSS | 30 | V | |
| Gate-Source Voltage | | | Vgss | ±8 | | |
| Continuous Drain Current (Note 5) V _{GS} = 4.5V | Steady State | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | lD | 1.3 1.1 | А | |
| Maximum Continuous Body Diode Forward Current (Note 5) | | | ls | 0.96 | A | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | Ідм | 3 | A | |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|--|--------------|------------------|-------------|------|
| Total Power Dissipation (Note 6) | | PD | 0.49 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | R _{0JA} | 253 | °C/W |
| Total Power Dissipation (Note 5) | · | PD | 1.12 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | Reja | 112 | °C/W |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +150 | °C |

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-----------------------------------|---------------------|------|------|------|------|---|
| OFF CHARACTERISTICS (Note 7) | | | | | | |
| Drain-Source Breakdown Voltage | BVDSS | 30 | _ | | V | $V_{GS} = 0V, I_{D} = 10\mu A$ |
| Zero Gate Voltage Drain Current | IDSS | _ | _ | 1 | μΑ | $V_{DS} = 30V, V_{GS} = 0V$ |
| Gate-Source Leakage | lgss | _ | — | 3 | μΑ | $V_{GS} = \pm 8V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 7) | | | | | | |
| Gate Threshold Voltage | VGS(TH) | 0.45 | — | 0.95 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ |
| | | | 280 | 460 | | $V_{GS} = 4.5V, I_D = 200mA$ |
| Static Drain-Source On-Resistance | R _{DS(ON)} | _ | 330 | 560 | mΩ | $V_{GS} = 2.5V, I_D = 100mA$ |
| | | | 400 | 730 | | $V_{GS} = 1.8V, I_D = 75mA$ |
| Diode Forward Voltage | Vsd | | 0.7 | 1.2 | V | $V_{GS} = 0V, I_{S} = 300mA$ |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | |
| Input Capacitance | Ciss | | 40.8 | | pF | |
| Output Capacitance | Coss | | 7.6 | — | pF | V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz |
| Reverse Transfer Capacitance | Crss | | 4.6 | — | pF | |
| Total Gate Charge | Qg | _ | 0.9 | — | nC | |
| Gate-Source Charge | Qgs | | 0.05 | | nC | VGS = 4.5V, VDS = 15V ID = 1A |
| Gate-Drain Charge | Qgd | | 0.3 | — | nC | |
| Turn-On Delay Time | td(on) | | 1.1 | — | ns | |
| Turn-On Rise Time | t _R | _ | 15.9 | _ | ns | V _{DS} = 10V, I _D = 1A |
| Turn-Off Delay Time | tD(OFF) | _ | 20.7 | | ns | $V_{GS} = 10V, R_G = 6\Omega$ |
| Turn-Off Fall Time | tF | | 20.0 | _ | ns | |
| Reverse Recovery Time | trr | _ | 59 | | ns | IF = 1A, dl/dt = 100A/µs |
| Reverse Recovery Charge | Q _{RR} | | 25 | | nC | I _F = 1A, dI/dt = 100A/µs |

Notes:

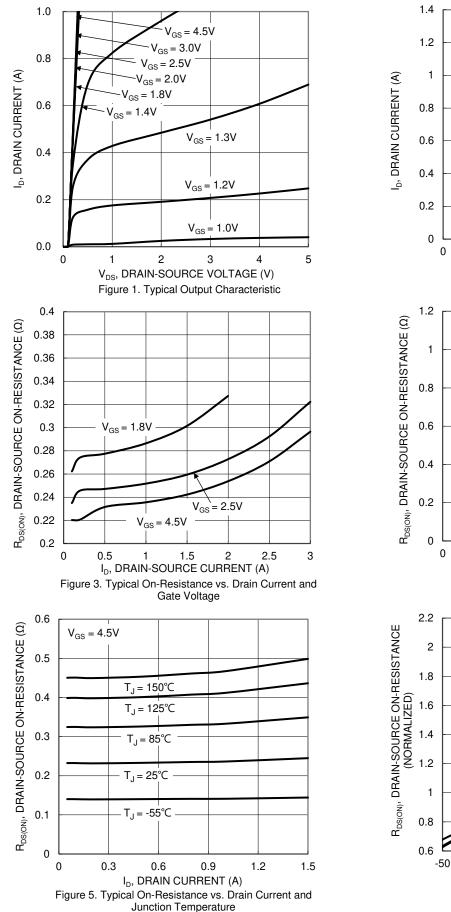
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

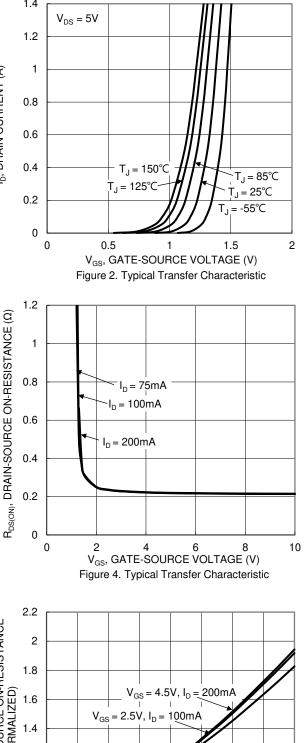
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.









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-25

0

25

50

Figure 6. On-Resistance Variation with Junction

Temperature

T_J, JUNCTION TEMPERATURE (°C)

 $V_{GS} =$

75

 $1.8V, I_{D} = 75mA$

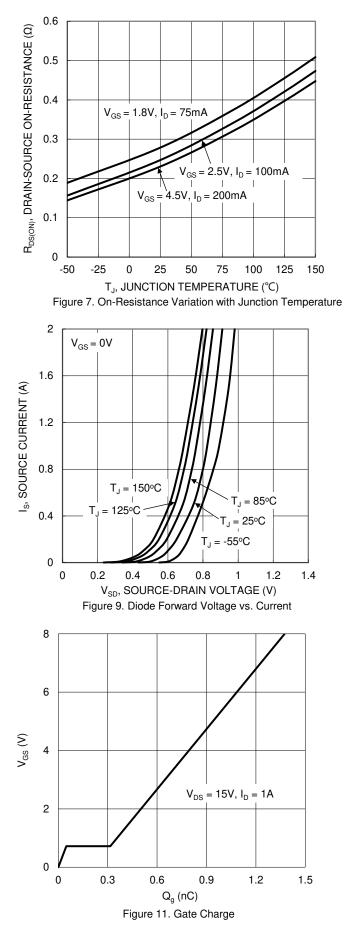
100

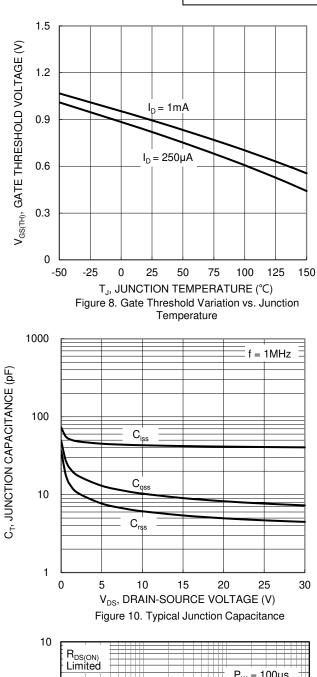
125

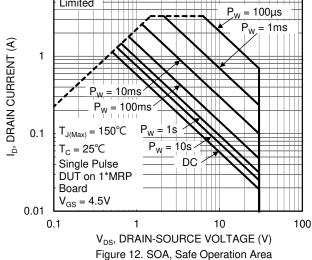
150



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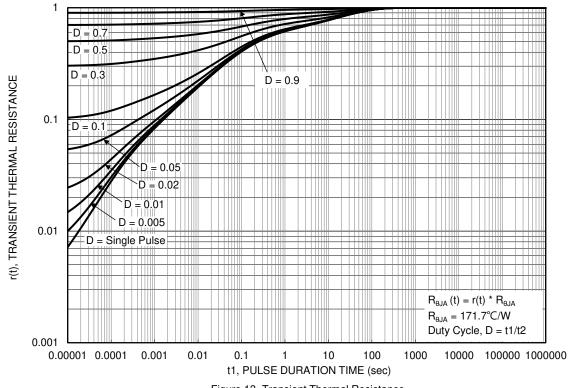


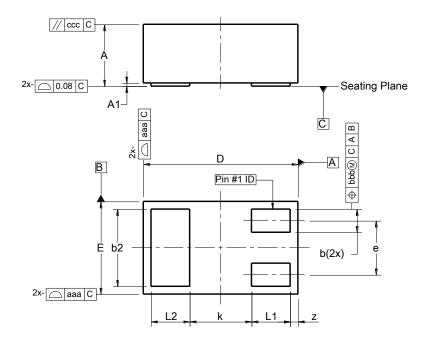
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3

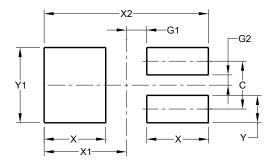


| Х | X2-DFN1006-3 | | | | | | |
|----------------------|--------------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | | 0.40 | | | | | |
| A1 | 0.00 | 0.05 | 0.03 | | | | |
| b | 0.10 | 0.20 | 0.15 | | | | |
| b2 | 0.45 | 0.55 | 0.50 | | | | |
| D | 0.95 | 1.05 | 1.00 | | | | |
| Е | 0.55 | 0.65 | 0.60 | | | | |
| e | 1 | - | 0.35 | | | | |
| L1 | 0.20 | 0.30 | 0.25 | | | | |
| L2 | 0.20 | 0.30 | 0.25 | | | | |
| k | 1 | 1 | 0.40 | | | | |
| Z | 0.02 | 0.08 | 0.05 | | | | |
| aaa | 0.15 | | | | | | |
| bbb | 0.05 | | | | | | |
| CCC | 0.05 | | | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-3



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 0.350 |
| G1 | 0.150 |
| G2 | 0.075 |
| Х | 0.450 |
| X1 | 0.600 |
| X2 | 1.200 |
| Y | 0.200 |
| Y1 | 0.550 |



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